V15PM12

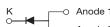
Vishay General Semiconductor

High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.48$ V at $I_F = 5$ A

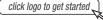


www.vishay.com



Anode 2 Cathode

DESIGN SUPPORT TOOLS





PRIMARY CHARACTERISTICS				
I _{F(AV)}	15 A			
V _{RRM}	120 V			
I _{FSM}	220 A			
V _F at I _F = 15 A (125 °C)	0.63 V			
T _J max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A) Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 gualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	V15PM12	UNIT		
Device marking code		15M12			
Maximum repetitive peak reverse voltage	V _{RRM}	120	V		
Maximum DC forward current	I _{F(AV)} ⁽¹⁾	15	A		
	I _{F(AV)} ⁽²⁾	4.2			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	220	A		
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C		
Storage temperature range	T _{STG}	-55 to +175	°C		

Notes

⁽¹⁾ Mounted on 30 mm x 30 mm pad areas aluminum PCB

⁽²⁾ Free air, mounted on recommended pad area

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

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FREE



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V15PM12

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 5 A$	T _A = 25 °C	V _F (1)	0.55	-	V
	I _F = 7.5 A			0.62	-	
	I _F = 15 A			0.76	0.84	
	I _F = 5 A	T _A = 125 °C		0.48	-	
	I _F = 7.5 A			0.53	-	
	I _F = 15 A			0.63	0.71	
Reverse current	V _R = 90 V	T _A = 25 °C	I _R ⁽²⁾	0.02	-	- mA
	v _R = 90 v	T _A = 125 °C		3	-	
	V _R = 120 V	T _A = 25 °C		-	0.80	
	v _R = 120 v	T _A = 125 °C		6	36	
Typical junction capacitance	4.0 V, 1 MHz		CJ	1450	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified)				
PARAMETER	SYMBOL	V15PM12	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾⁽²⁾	75	°C/W	
	R _{0JM} ⁽³⁾	4		

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

⁽²⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(3)}$ Units mounted on 30 mm x 30 mm aluminum PCB, thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V15PM12-M3/H	0.10	Н	1500	7" diameter plastic tape and reel	
V15PM12-M3/I	0.10	I	6500	13" diameter plastic tape and reel	
V15PM12HM3/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel	
V15PM12HM3/I ⁽¹⁾	0.10	I	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

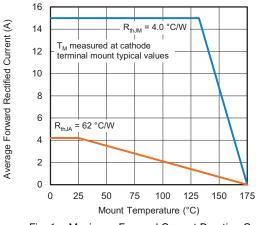


Fig. 1 - Maximum Forward Current Derating Curve

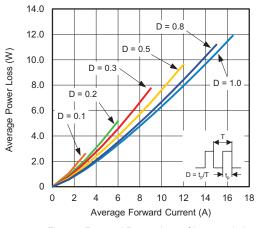


Fig. 2 - Forward Power Loss Characteristics

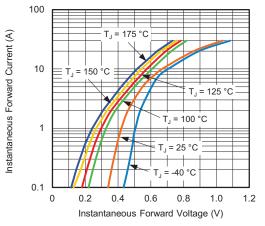
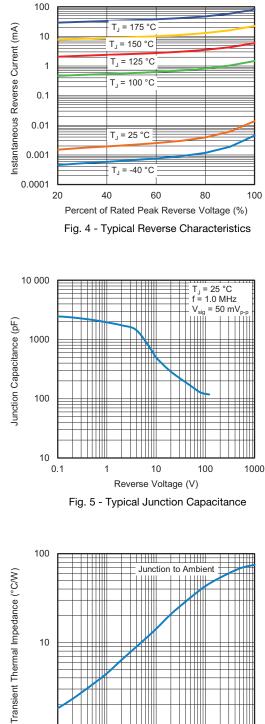


Fig. 3 - Typical Instantaneous Forward Characteristics



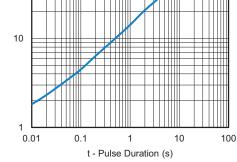


Fig. 6 - Typical Transient Thermal Impedance

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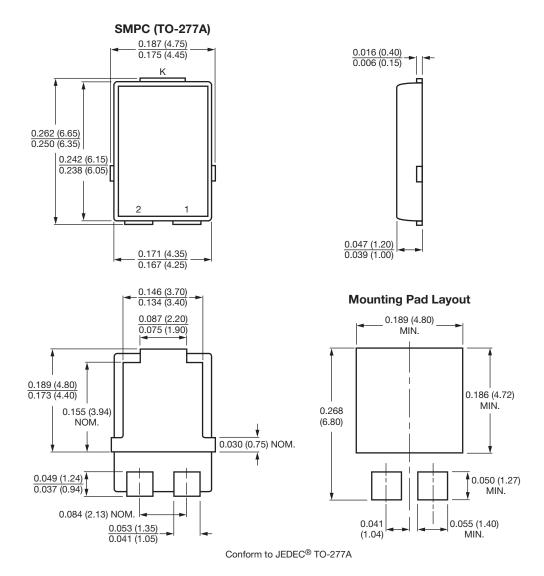
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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